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# **Electrical Discharge Machining (EDM) and EDM-Based Hybrid Machining**

Guest Editor:

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Deadline for manuscript submissions:

closed (30 April 2023)

## **Message from the Guest Editor**

Dear Colleagues,

I would like to invite you to submit your unpublished research on any aspect of electrical discharge machining (EDM) to this Special Issue. Electrical discharge machining (EDM) is one of earliest and most widely used nontraditional machining processes commonly used to machine difficult-to-cut materials. For the capability of machining materials irrespective of their hardness, EDM has found important applications in automotive, electronic, packaging, telecommunication, aerospace, and biomedical industries.

Specific topics of interest include but are not limited to:

- Multiscale EDM processes, i.e., conventional EDM, micro-EDM, nano-EDM;
- Die-sinker and wire-EDM processes;
- Variations of EDM, i.e., micro-EDM drilling, micro-EDM milling, orbital EDM, Reverse EDM, dry EDM, etc.:
- EDM-based hybrid processes, or assisted EDM processes, i.e., vibration-assisted EDM, laserassisted EDM, powder-mixed EDM, etc.;
- ..

For further information, please visit <a href="mdpi.com/si/54955">mdpi.com/si/54955</a>.











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## **Message from the Editor-in-Chief**

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